

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT

**CONVEYING PARTY DATA**

Name	Execution Date
Toshiki NAKAMURA	04/24/2009
Junichi YONEMARU	04/24/2009
Goro ISHIKAWA	04/24/2009
Tomoya SHINBATA	04/24/2009
Mika SAITO	04/24/2009
Hideyo YASUDA	04/24/2009
Yasuhiro SETO	04/24/2009
Yoichi KURIMOTO	04/24/2009
Yoshikazu ISHIHARA	04/24/2009

**RECEIVING PARTY DATA**

<b>Name:</b>	National Agriculture and Food Research Organization
<b>Street Address:</b>	3-1-1, Kannondai
<b>City:</b>	Tsukuba-shi, Ibaraki
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	3058517

<b>Name:</b>	NIPPON FLOUR MILLS CO., LTD.
<b>Street Address:</b>	27-5, Sendagaya 5-chome
<b>City:</b>	Shibuya-ku, Tokyo
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	1518537

**PROPERTY NUMBERS Total: 1**

Property Type	Number
<b>Application Number:</b>	12513058

**CORRESPONDENCE DATA**

**CH \$40.00 12513058**

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Total Attachments: 2

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For Non-U.S. Clients

### Assignment

Whereas, I/We, ①Toshiki NAKAMURA ②Junichi YONEMARU ③Goro ISHIKAWA ④Tomoya SHINBATA ⑤Mika SAITO ⑥Hideyo YASUDA ⑦Yasuhiro SETO ⑧Yoichi KURIMOTO ⑨Yoshikazu ISHIHARA of ①-③ of c/o National Agricultural Research Center for Tohoku Region, 4 Aza Akahira, Shimo-kuriyagawa, Morioka-shi, Iwate 0200198 Japan

④-⑨ c/o CENTRAL LABORATORY, NIPPON FLOUR MILLS CO., LTD., 5-1-3, Midorigaoka, Atsugi-shi, Kanagawa 2430041 Japan hereinafter called assignor(s), have invented certain improvements in CEREAL FLOUR COMPOSITION CONTAINING WHEAT FLOUR FROM SWEET WHEAT AND FOOD PRODUCT USING THE SAME

and executed an application for Letters Patent of the United States of America therefor on April 24, 2009; and

Whereas,

①National Agriculture and Food Research Organization (50%)

3-1-1, Kannondai, Tsukuba-shi, Ibaraki 3058517 Japan

②NIPPON FLOUR MILLS CO., LTD. (50%)

27-5, Sendagaya 5-chome, Shibuya-ku, Tokyo 1518537 Japan

(Their rights and interests to apply for and obtain the Patent in this invention (percentage) (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including the right to claim priority under 35 U.S.C. §119, and I/we request the Director – U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

I/We hereby authorize and request our attorneys SUGHRUE MION, PLLC of 2100 Pennsylvania Avenue, NW, Washington, DC 20037-3213 to insert here in parentheses (Application number 12513058 and Confirmation number 8922, filed April 30, 2009) the filing date and application number of said application when known.

Date: April 24, 2009

s/ Toshiki NAKAMURA

Date: April 24, 2009

s/ Junichi YONEMARU

Date: April 24, 2009

s/ Goro ISHIKAWA

Date: April 24, 2009

s/ Tomoya SHINBATA

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. §261)

Date: April 24, 2009

*M. Saito*

s/ Mika SAITO

Date: April 24, 2009

*Hideyo Yasuda*

s/ Hideyo YASUDA

Date: April 24, 2009

*Yasuhiro Seto*

s/ Yasuhiro SETO

Date: April 24, 2009

*Yoichi Kurimoto*

s/ Yoichi KURIMOTO

Date: April 24, 2009

*Yoshikazu Ishihara*

s/ Yoshikazu ISHIHARA